Drawing No.: RPC-K-HTS-0003 /2

Date: 2024. 12. 24

# Data sheet

Title: FIXED THICK FILM CHIP RESISTORS;
RECTANGULAR TYPE AND ANTI SURGE

Style: RPC16, 20, 32, 35, 50, 63

AEC-Q200 qualified

RoHS COMPLIANCE ITEM
Halogen and Antimony Free

Note: •Stock conditions

Temperature:  $+5^{\circ}\text{C} \sim +35^{\circ}\text{C}$ Relative humidity:  $25\% \sim 75\%$ 

The period of guarantee: Within 2 year from shipment by the company.

Solderability shall be satisfied.

- Product specification contained in this data sheet are subject to change at any time without notice
- If you have any questions or a Purchasing Specification for any quality agreement is necessary, please contact our sales staff.



Hokkaido Research Center Approval by: T. Sannomiya Drawing by: M. Shibuya

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### 1. Scope

1.1 This data sheet covers the detail requirements for fixed thick film chip resistors; rectangular type & anti surge, style of RPC16, 20, 32, 35, 50, 63.

### 1.2 Applicable documents

JIS C 5201-1: 2011, IEC60115-1: 2008, AEC-Q200 Rev.D

### 2. Classification

Type designation shall be the following form.

(Example)

1 Fixed thick film chip resistors; rectangular type and anti surge

— Style

2 Size

3 Rated resistance

475	E24 Series, 3 digit,	Ex. 475> 4.7MΩ,

4 Tolerance on rated resistance

J	±5%
K	±10%
М	±20%

5 Packaging form

gg	
TP	Paper taping
TE	Embossed taping

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# 3. Rating

3.1 The ratings shall be in accordance with Table-1.

Table-1

Style	Rated dissipation (W)	Temperature coefficient of resistance ( 10 <sup>-6</sup> / °C)	Rated resistance range( $\Omega$ )	Preferred number series for resistors	Tolerance on rated resistance
DDC46	0.25	±100	10~1M	E24	V   E9/ )
RPC16	0.25	±200	1.0~9.1	□ ⊏24	J(±5%)
		±200	1.1M~22M		
RPC20	0.25	±100	1.0~1M	E24	J(±5%), K(±10%), M(±20%)
		±200	0.27~0.91		
		±200	1.1M~22M		
RPC32	0.33	±100	1.0~1M	E24	J(±5%), K(±10%), M(±20%)
		±200	0.27~0.91		
		±200	1.1M~22M		
RPC35	0.5	±100	1.0~1M	E24	J(±5%), K(±10%), M(±20%)
		±200	0.27~0.91		
		±200	1.1M~22M		
RPC50	0.75	±100	1.0~1M	E24	J(±5%), K(±10%), M(±20%)
		±200	0.27~0.91		
		±200	1.1M~22M		
RPC63	1.0	±100	1.0~1M	E24	J(±5%), K(±10%), M(±20%)
		±200	0.27~0.91		

Style	Limiting element voltage (V)	Insulation voltage (V)	Category temperature range (°C)
RPC16	150	150	
RPC20	150		
RPC32			FE   155
RPC35	200	500	<i>–</i> 55∼+155
RPC50	200		
RPC63			

### 3.2 Derating

The derated values of dissipation at temperature in excess of 70 °C shall be as indicated by the following curve.

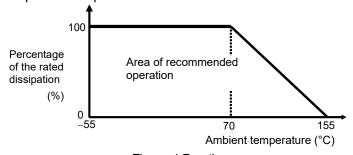


Figure-1 Derating curve

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# 3.3 Rated voltage

d. c. or a. c. r. m. s. voltage calculated from the square root of the product of the rated resistance and the rated dissipation.

$$E = \sqrt{P \cdot R}$$

E : Rated voltage (V)
P : Rated dissipation (W)

R: Rated resistance ( $\Omega$ )

Limiting element voltage can only be applied to resistors when the resistance value is equal to or higher than the critical resistance value.

At high value of resistance, the rated voltage may not be applicable.

# 4. Packaging form

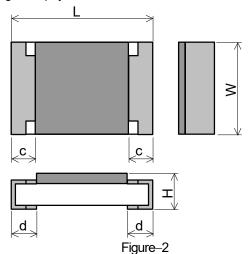
The standard packaging form shall be in accordance with Table-2.

Table-2

Symbol	ol Packaging form		Standard packaging quantity / units	Application
TP	Paper taping	8mm width, 4mm pitches	5,000 pcs.	RPC16, 20, 32
TE	Embassed taning	8mm width, 4mm pitches	4 000 ncs	RPC35
IE	Embossed taping 12mm v	12mm width, 4mm pitches		RPC50, 63

### 5. Dimensions

5.1 The resistor shall be of the design and physical dimensions in accordance with Figure-2 and Table-3.



Table–3 Unit: mm

Style	L	W	Н	С	d
RPC16	1.6±0.1	$0.8^{+0.15}_{-0.05}$	0.45±0.10	0.3±0.2	0.3±0.1
RPC20	$2.0 \pm 0.1$	$1.25 \pm 0.10$	$0.55 \pm 0.10$	$0.3 \pm 0.2$	$0.4 \pm 0.2$
RPC32	$3.1 \pm 0.1$	1.6 ± 0.15	$0.55 \pm 0.10$	$0.3 \pm 0.2$	$0.5 \pm 0.25$
RPC35	3.1 ± 0.15	$2.5 \pm 0.15$	$0.55 \pm 0.15$	$0.3 \pm 0.2$	$0.5 \pm 0.25$
RPC50	$5.0 \pm 0.15$	$2.5 \pm 0.15$	$0.55 \pm 0.15$	$0.3 \pm 0.15$	$0.6 \pm 0.2$
RPC63	6.3 ± 0.15	$3.2 \pm 0.15$	$0.55 \pm 0.15$	$0.3 \pm 0.15$	$0.6 \pm 0.2$

# 5.2 Net weight (Reference)

O.Z I VCI WOIG	3.2 race weight (nationalise)			
Style	Net weight(mg)			
RPC16	2			
RPC20	5			
RPC32	9			
RPC35	16			
RPC50	25			
RPC63	40			

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# 6. Marking

The Rated resistance shall be marked in 3 digits (E24) and marked on over coat side.

Marking example	Contents	Application
123	12×10 <sup>3</sup> $[\Omega] \rightarrow$ 12 $[k\Omega]$	E24
2R2	2.2 [Ω]	E24

### 7. Performance

- 7.1 The standard condition for tests shall be in accordance with Sub-clause 4.2, JIS C 5201-1: 2011.
- 7.2 The performance shall be satisfied in Table-4.

Table-4(1)

No	Test items	Condition of test	Performance requirements
		NUL OTO COOM II LACO	
1	High temperature exposure	MIL-STD-202 Method 108	$\Delta$ R/R: Within $\pm$ (2%+0.1 $\Omega$ )
	AEC Q200 - No.3	Ambient temperature:155±2°C,	No visible damage
		Condition: Without load,	
		Duration: 1000 +48 h	
	<del>-</del>	Interval measurements: 250 h and 500 h	
2	Temperature cycling	JESD22 Method JA-104	$\Delta$ R/R: Within $\pm$ (1%+0.05 $\Omega$ )
	AEC Q200 - No.4	Temperature: -55±3°C / 125±2°C,	No visible damage
		Dwell time: 30min maximum at each temp.	
		Transition time: 1 min. max.	
		Number of cycles: 1000 cycles.	
3	Dice burnidity	Interval measurements: 250 cy and 500 cy MIL-STD-202 Method 103	AD/D W/#: + (00/ - 0.40)
3	Bias humidity AEC Q200 – No.7		$\Delta$ R/R: Within ±(2%+0.1 $\Omega$ )
	AEC Q200 - No.7	Condition: 85°C & 85% R.H.	No visible damage
		Test power: 10% of rated power shall be	
		applied for continuously.	
		Duration: 1,000 +48 h	
	0 0 175	Interval measurements: 250 h and 500 h	
4	Operational life	MIL-STD-202 Method 108	$\Delta$ R/R: Within ±(2%+0.1 $\Omega$ )
	AEC Q200 – No.8	Ambient temperature: 125±2°C	No visible damage
		The applied voltage shall be the voltage to be calculated at 35% of rated dissipation or the	
		limiting element voltage whichever is the	
		smaller.	
		Condition: The voltage shall be applied for	
		continuously.	
		+48	
		· ·	
		Interval measurements: 250 h and 500 h	
5	External Visual	MIL-STD-883 Method 2009	Inspect device construction, marking
	AEC Q200 – No.9		and workmanship.
6	Dimensions	JESD22 Method JB-100	As in Table 2
6	AEC Q200 – No.10	JEODZZ IVICUIOU JD-100	As in Table–3
7	Resistance to Solvents	MIL-STD-202 Method 215	$\Delta$ R/R: Within ±(1%+0.05 $\Omega$ )
'	AEC Q200 – No.12	Solvent: 2-propanol at 25°C	No visible damage
	, LO Q200 110.12	Immersion time: 3 min	TWO VISIDIE GALLIAGE
		Brush: 10 times brushing	
		Immersion and brush cycle: 3cycle	
8	Mechanical Shock	MIL-STD-202 Method 213	$\Delta$ R/R: Within ±(0.5%+0.05 $\Omega$ )
	AEC Q200 – No.13	Waveform: half sine,	No visible damage
	, 3200 110.10	Peak value 100G,	110 VISIDIO GAITIAGO
		Normal duration 6ms	
		Condition: XX'YY'ZZ', 18times total	
	1		

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Table-4(2)

No	Test items	Condition of test	Performance requirements
9	Vibration	MIL-STD-202 Method 204	$\Delta$ R/R: Within $\pm$ (0.5%+0.05 $\Omega$ )
	AEC Q200 – No.14	Peak acceleration and Sweep time: 5 g's for 20	No visible damage
	7.20 0.200 1.0111	min , Frequency 10Hz to 2000Hz,	The visible damage
		Condition: 12 cycles each of 3 orientations	
10	Resistance to soldering heat	MIL-STD-202 Method 210	$\Delta$ R/R: Within $\pm$ (0.5%+0.05 $\Omega$ )
	AEC Q200 - No.15	Solder bath temp: 260±5°C	No visible damage
		Immersed time: 10±1s	3
11	ESD test	AEC-Q200-002	$\Delta$ R/R: Within $\pm$ (5%+0.1 $\Omega$ )
	AEC Q200 - No.17	Human body model, 2 Kohm, 150 pF,	No visible damage
		Test voltage: 2000V	· ·
12	Solderability	J-STD-002	The surface of terminal immersed
	AEC Q200 - No.18	a) Bake the sample for 155 °C dwell time 4h /	shall be min. of 95% covered with a
		solder dipping 235°C/5s.	new coating of solder.
		Solder: Sn96.5-Ag3-Cu0.5	
		b) Category 3, Solder dipping 215°C/ 5s.	
		Solder: Sn63Pb37	
		c) Category 3, Solder dipping 260°C/30s.	
13	Electrical Characterization	1. D.C. Resistance	1. The resistance value shall
	AEC Q200 - No.19	Temperature Coefficient of Resistance	correspond with the rated
		-55 °C / +20°C	resistance taking into account the
		+20 °C / +155°C	specified tolerance.
			2. As in Table–1
14	Flammability	UL-94	V-0 or V-1 are acceptable
	AEC Q200 – No.20		
15	Bending strength	AEC-Q200-005	$\Delta$ R/R: Within $\pm$ (0.5%+0.05 $\Omega$ )
	AEC Q200 – No.21	Bending value2mm	No visible damage
		Holding time: 60sec.	
16	Adhesion	AEC-Q200-006	$\Delta$ R/R: Within $\pm$ (0.5%+0.05 $\Omega$ )
	AEC Q200 – No.22	Pressurizing force:	No visible damage
		RPC20,32,35,50,63 17.7N	
		RPC16 10N	
L	<u> </u>	Test time: 60±1s.	
17	Flame retardance	AEC-Q200-001	The following FAILURE CRITERIA
	AEC Q200 – No.24	Test conditions: 9VDC to 32VDC Each 1h	does not occur.
		This test applies to rated voltages of 32V and	FAILURE CRITERIA
		above.	- Electrically open
			a) A flame over 3.0 seconds duration
			b) An explosion
			c) A temperature above 350°C
			sustained for over 10 s

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# 8. Taping

- 8.1 Applicable documents JIS C 0806-3: 2014, EIAJ ET-7200C: 2010
- 8.2 Taping dimensions
- 8.2.1 Paper taping (8mm width, 4mm pitches)

Taping dimensions shall be in accordance with Figure-3 and Table-5.

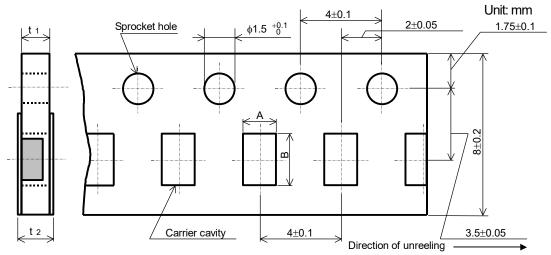


Figure-3

	Unit: mm			
Style	Α	В	t 1	t 2
RPC16	1.15 ± 0.15	$1.9 \pm 0.2$	$0.6 \pm 0.1$	0.8max.
RPC20	1.65±0.15	2.5±0.2	0.8±0.1	1.0max.
RPC32	2.00±0.15	3.6±0.2	U.O±U. I	1.0Hax.

# 8.2.2 Embossed taping dimensions shall be in accordance with Figure-4 and Table-6.

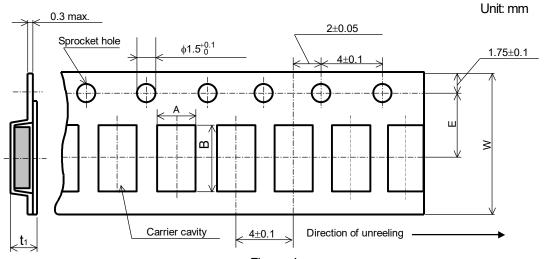
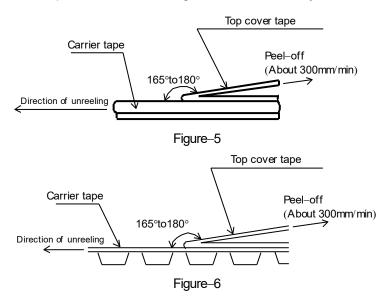


Figure 4

	Unit: mm				
Style	Α	В	W	E	<b>t</b> 1
RPC35	2.85±0.2	3.5±0.2	8.0±0.3	3.5±0.05	1.0±0.2
RPC50	3.1±0.2	5.5±0.2	12.0±0.3	5.5±0.05	1 1+0 15
RPC63	3.6±0.2	6.9±0.2	12.0±0.3	5.5±0.05	1.1±0.15

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- 1). The cover tapes shall not cover the sprocket holes.
- 2). Tapes in adjacent layers shall not stick together in the packing.
- 3). Components shall not stick to the carrier tape or to the cover tape.
- 4). Pitch tolerance over any 10 pitches ±0.2mm.
- 5). The peel strength of the top cover tape shall be with in 0.1N to 0.5N on the test method as shown in the following RPC16, 20, 32: Figure–5, RPC35, 50, 63: Figure–6.
- 6). When the tape is bent with the minimum radius for RPC16, 20, 32, 35: 25 mm, or RPC50, 63: 30 mm, the tape shall not be damaged and the components shall maintain their position and orientation in the tape.
- 7). In no case shall there be two or more consecutive components missing.
  The maximum number of missing components shall be one or 0.1%, whichever is greater.
- 8). The resistors shall be faced to upward at the over coating side in the carrier cavity.



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#### 8.3 Reel dimension

Reel dimensions shall be in accordance with the following Figure–7 and Table–7. Plastic reel (Based on EIAJ ET–7200C)

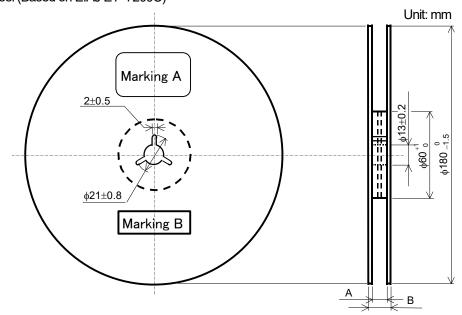
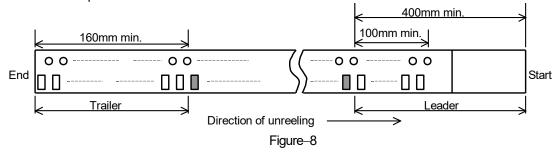


Figure-7

	Unit: mm			
Style	Α	В	Note	
RPC16,20,32,35	9 +1.0	11.4±1.0	Injection molding	
TAF C 10,20,32,33		13±1.0	Vacuum forming	
RPC50,63	13 <sup>+1.0</sup>	17±1.0	Vacuum forming	

Note: Marking label shall be marked on a place of Marking A or two place of Marking A and B.

### 8.4 Leader and trailer tape.



# 9. Marking on package

The label of a minimum package shall be legibly marked with follows.

- 9.1 Marking A
  - (1) Classification (Style, Rated resistance, Tolerance on rated resistance, Packaging form)
  - (2) Quantity (3) Lot number (4) Manufacturer's name or trade mark (5) Others
- 9.2 Marking B (KAMAYA Control label)